

KENMEC Investor Briefing

2026.08.19

TPEX 6125

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PART 01 SECTION OVERVIEW

Company profile and Financial information

KENMEC Main individual companies in consolidated statements

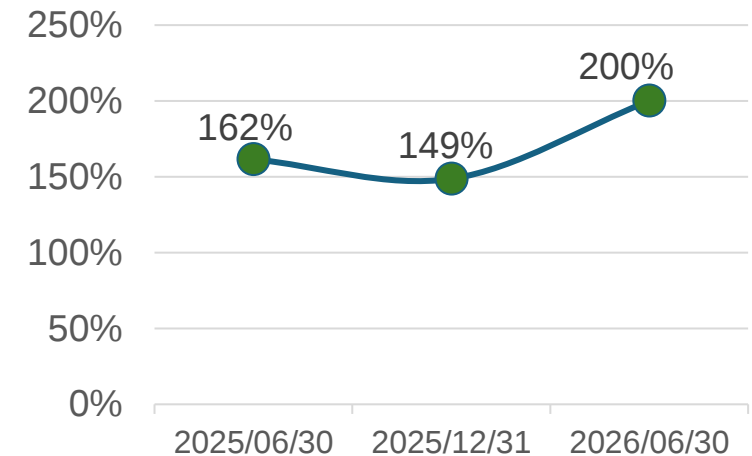
Company / Code	Capital	Major Product
KENMEC 6125 	2.59 Billion	Smart Manufacturing & Logistics Semiconductor Logistics (OHT/AMR) Public Works Digital Twin Integration AI Product Agency 
TAINERGY 4934 	2.25 Billion	Tai Chi - Solar Cells, Charging Stations, Yongyang - Silicone Gel Contact Lenses 
TAISIC 6930 	0.9 Billion	Type III Semiconductors: Silicon Carbide (SiC) Crystal Growth N-type-Conductive: Automotive Si-type-Semi-insulating: Heat dissipation, Semiconductors, Communication Infrastructure 
KENTEC 6125 	0.66 Billion	Thermal Management Business Electronics Manufacturing Services 

Consolidated Balance Sheet

Unit: NT\$ 100 million

Accounting Subject	2026/6/30	2025/12/31	2025/6/30
Current assets	55.91	51.07	47.18
Non-current assets	68.51	66.57	64.97
Total assets	124.42	117.64	112.15
Current liabilities	27.94	34.33	29.19
Non-current liabilities	29.70	25.39	25.69
Total liabilities	57.64	59.72	54.88
Share capital	25.90	25.90	25.90
Capital surplus	14.23	12.48	12.50
Retained earnings	8.15	8.03	7.63
Other equity	(1.67)	(2.08)	(3.21)
Total equity attributable to owners of parent	46.61	44.33	42.83
Total Shareholders' equity (Including minority interest)	66.78	57.92	57.27
Liabilities Ratio	46%	51%	49%
Current Ratio	200%	149%	162%
Net Asset Value Per Share	18.00	17.12	16.53

Current Ratio



Consolidated Income Statement

Unit: NT\$ 100 million

Accounting Subject	A. 2026 H1		B. 2025 H1		C=Growth \$ A-B Growth %=C/B	
Net operating revenue	18.59	100%	13.31	100%	5.27	40%
Gross profit	4.20	22%	2.62	20%	1.58	60%
Net operating loss	(1.80)	10%	(2.59)	19%	0.79	31%
Net loss before tax	(0.98)	(5%)	(1.72)	(13%)	0.74	43%
Net loss after tax	(1.03)	(5%)	(1.75)	(13%)	0.72	41%
Net income after tax to Shareholders of Parent Company	0.38	2%	(0.12)	(1%)	0.50	432%
Net income after tax per share(NT\$)	0.15		(0.04)			

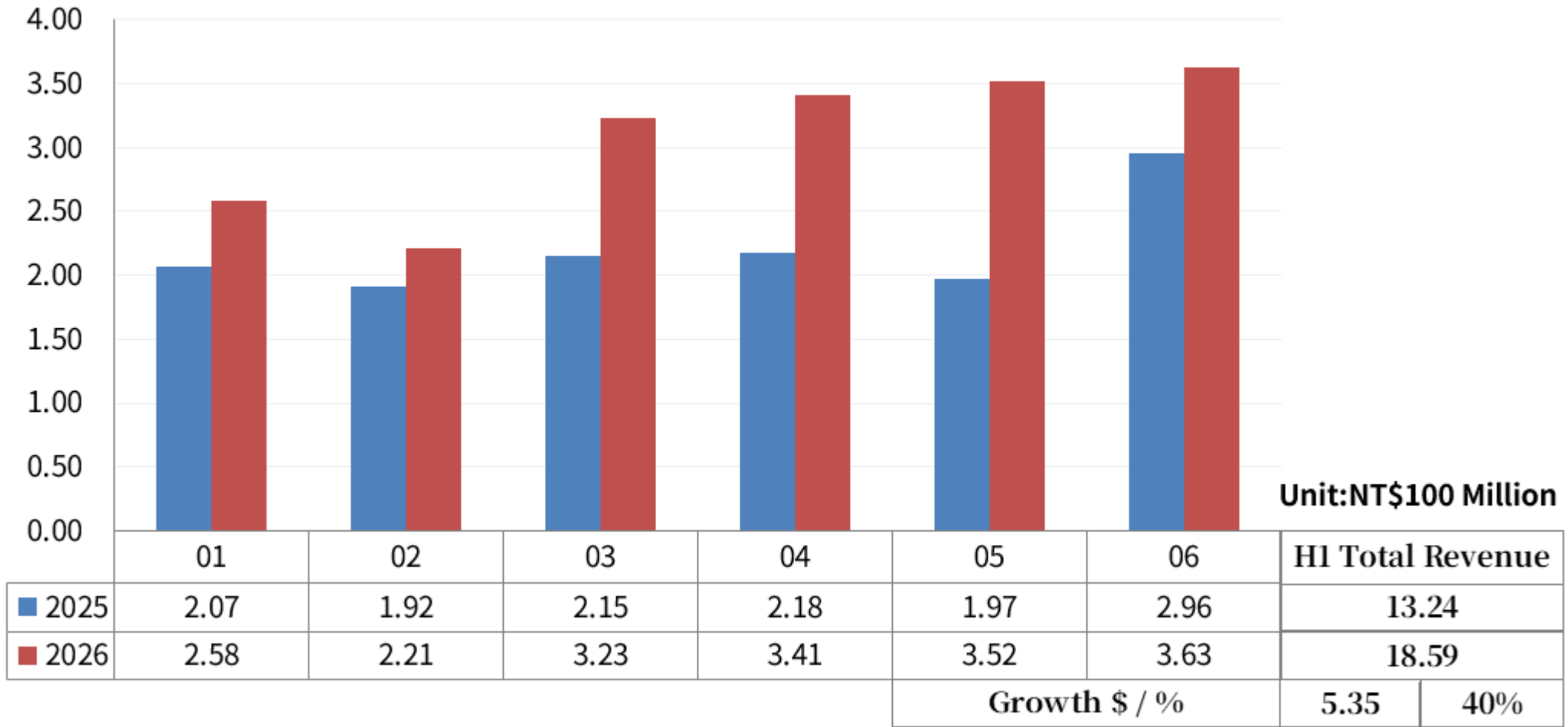
Consolidated Statement of Cash Flow

Unit: NT\$ 100 million

Accounting Subject	2026 H1	Year 2025	2025 H1
Cash flow from operating activities	(3.34)	2.79	0.36
Cash flows from investing activities	1.23	(3.90)	(0.62)
Cash flow from financing activities	9.38	(2.99)	(3.06)
The impact of exchange rate changes on cash and cash equivalents	0.08	0.12	(0.11)
Net increase (decrease) in cash and cash equivalents	7.34	(3.98)	(3.43)
Opening cash and cash equivalent balances	19.82	23.80	23.80
Closing cash and equivalent cash balances	27.16	19.82	20.37

Consolidated Revenue Comparison

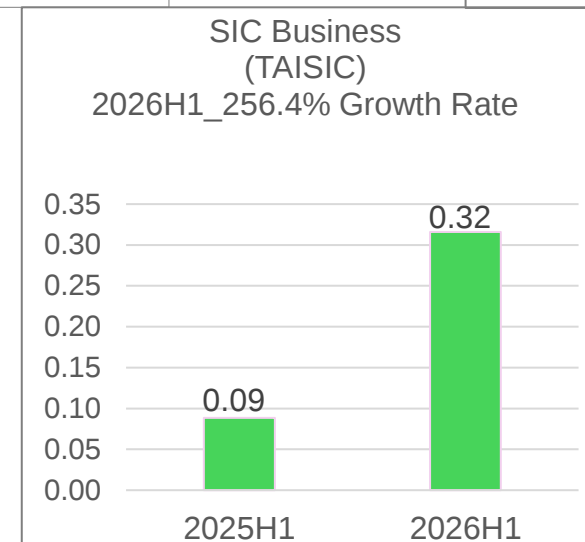
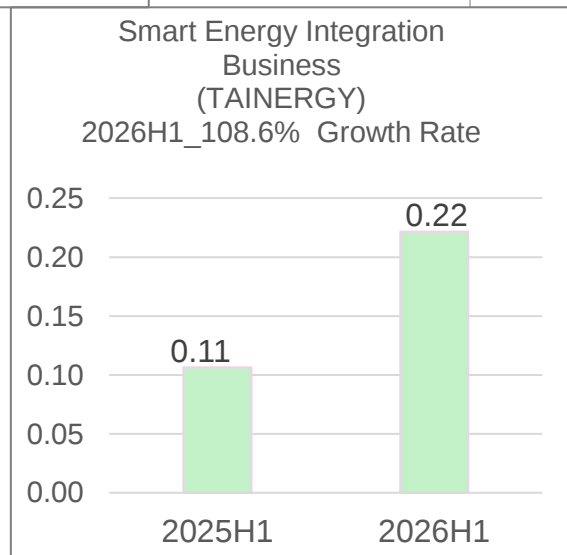
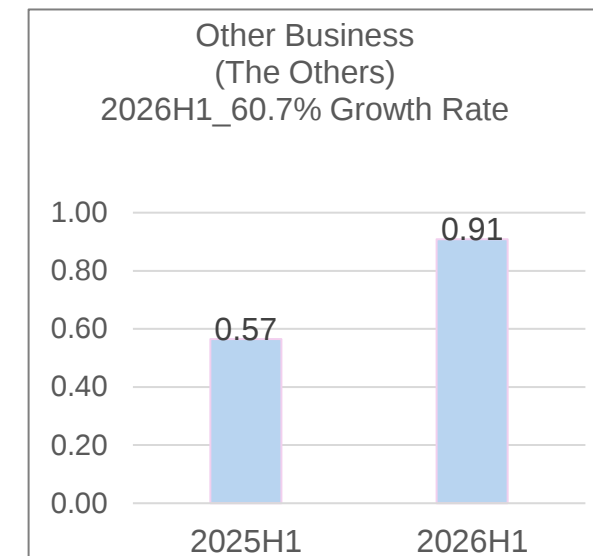
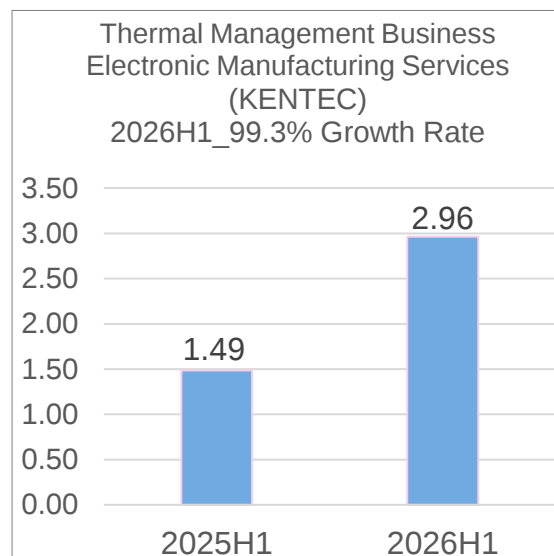
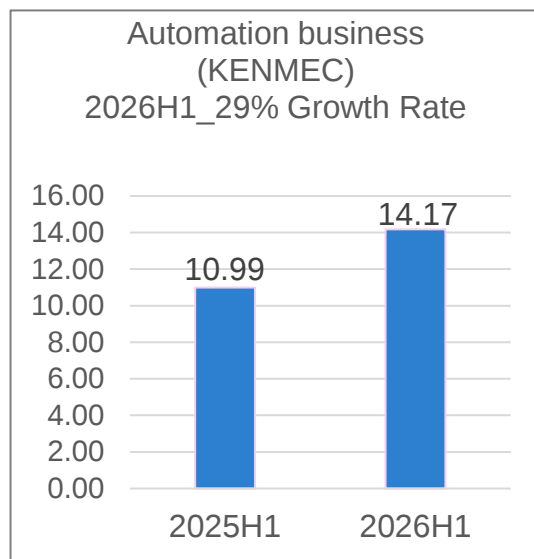
2026H1 VS 2025H1



Consolidated Revenue Comparison- By industry

2026H1 VS 2025H1

Unit: NT\$ 100 million



PART 02 SECTION OVERVIEW

Company Products and Achievements

Company Positioning & Vision

Positioning

Leader in Smart Manufacturing and Smart Logistics System Integration

- Core Focus: Smart manufacturing and logistics systems; public works and electromechanical integration; semiconductor logistics; AI product distribution; Digital Twin
- Expansion: Energy, Semiconductors, and AI Applications
- Goal: Become an “AI-driven industrial solutions platform”

Vision

Build a New Industry Model of Cyber-Physical Integration (Digital Twin)

From equipment and systems to industrial sites, create a visible, predictable, and optimizable closed loop.

Core Competencies

Three Dimensions Building an Industrial Moat



System Integration Capability

- From Equipment → Systems → Total Solutions
- Strong in cross-equipment and cross-process implementation



Cross-Industry Integration Capability

- Semiconductors × Energy × AI × Manufacturing
- Complementary strengths across group businesses



Technical Capability

- AI / Digital Twin / Automation Control
- Supports prediction, scheduling, O&M, and optimization

Building on equipment-level capabilities, KENMEC extends into system integration, cross-domain collaboration, and AI software capabilities.

AI-Driven One-Stop Smart Integration Service



Five Strategic Directions

Growing Together with Customers

Smart Manufacturing
Smart Logistics



Semiconductor Logistics OHT / AMR



Public Works



Cyber-Physical Integration Digital Twin



AI Product Distribution



NVIDIA SP

NVIDIA Partner Network - Solution Provider (SP) Program

Enhance Planning, Simulation, and Validation Efficiency with Digital Twin

Identify issues in the virtual environment first, then compare alternatives and validate the optimal solution

- Build digital models of equipment, production lines, and sites
- Compare layouts, flows, and operating logic
- Identify bottlenecks and potential conflicts in advance
- Improve planning quality and decision accuracy

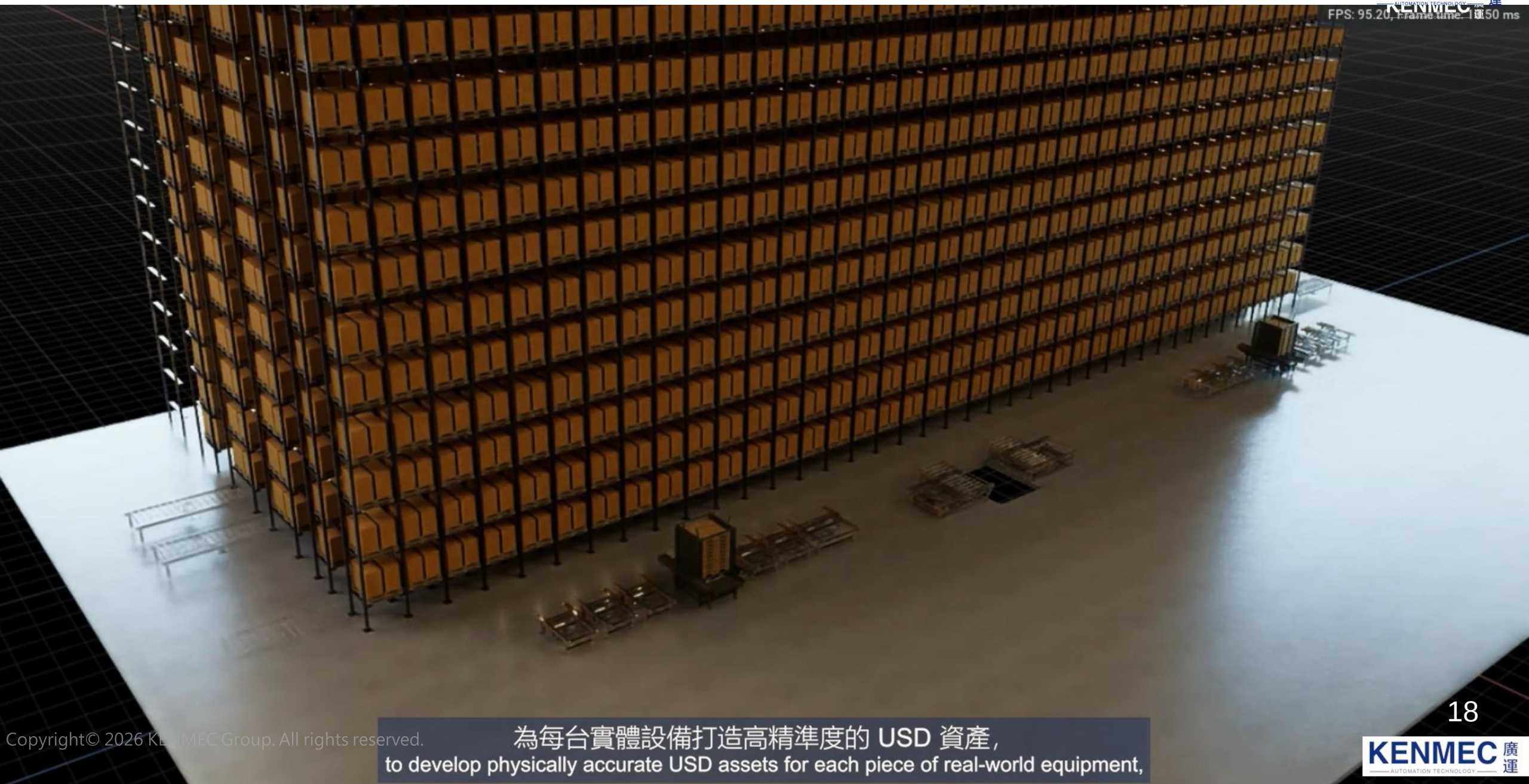


Digital Twin makes planning evidence-based, validation more complete, and decisions more precise.

Digital Twin - Smart Logistics Center

Features

- Simulating optimal solutions for different combinations
- Optimization and efficiency improvement of existing fields
- Reference basis for expanding fields



Digital Twin

– Semiconductor Production Line Application

Features

- Develop an OHT training environment to simulate automated overhead hoist transport in Omniverse.
- Use large-scale data for deep learning AI training to identify the optimal solution.



Digital Twin

– Baggage Handling Simulation Application

Features

1. Build a baggage handling simulation environment
2. Validate process flow and equipment layout
3. Support solution optimization and expansion assessment
4. Enhance pre-implementation visual communication



Localized Smart Railway

❑ Digital Twin



❑ Pantograph



❑ Train Doors



❑ Smart CCTV & AI Railcar

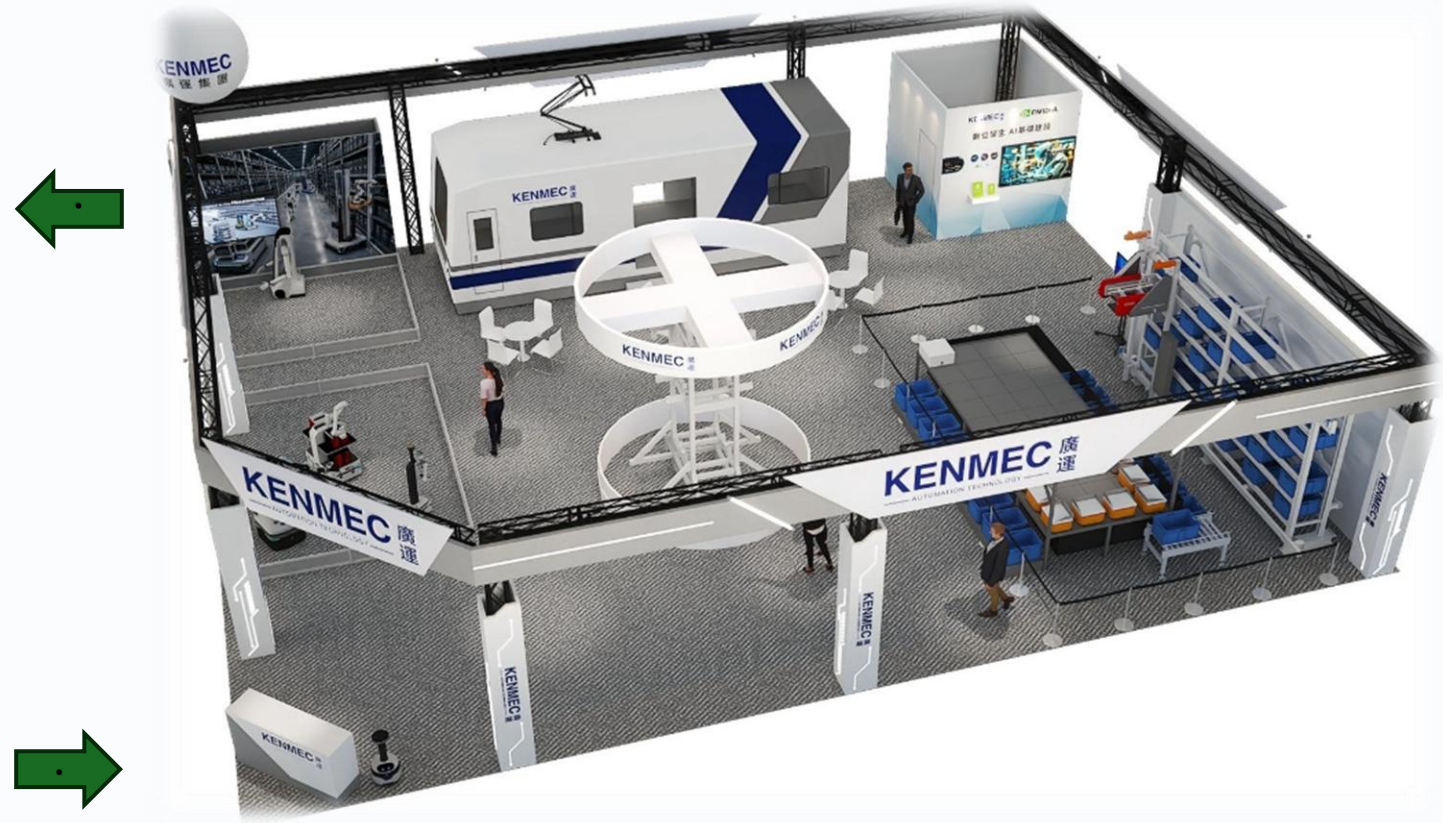


❑ VPSD Platform Screen Doors

2026 Railway Exhibition - Looking Towards the World



KENMEC Domestic Smart Train Exhibition Ruifang Factory
15-16 APR 2026 · NEW TAIPEI



Automation Taipei N814
19-22 AUG 2026 · TAIPEI

Ugo Pro – Full-Function Flagship Model

Dual-arm design can perform complex actions such as pressing elevator buttons, opening doors, and recognizing instruments.

- **Cross-floor operation:** can use elevators; one robot supports multiple floors
- **Multiple applications:** suitable for smart inspection, service, and high-interaction sites
- **Flexible expansion:** supports sensor module expansion with high adaptability
- **Free movement:** height-adjustable body and omnidirectional mobile base



Cyber-Physical Integration Digital Twin

Key capability supporting KENMEC's diverse application deployment

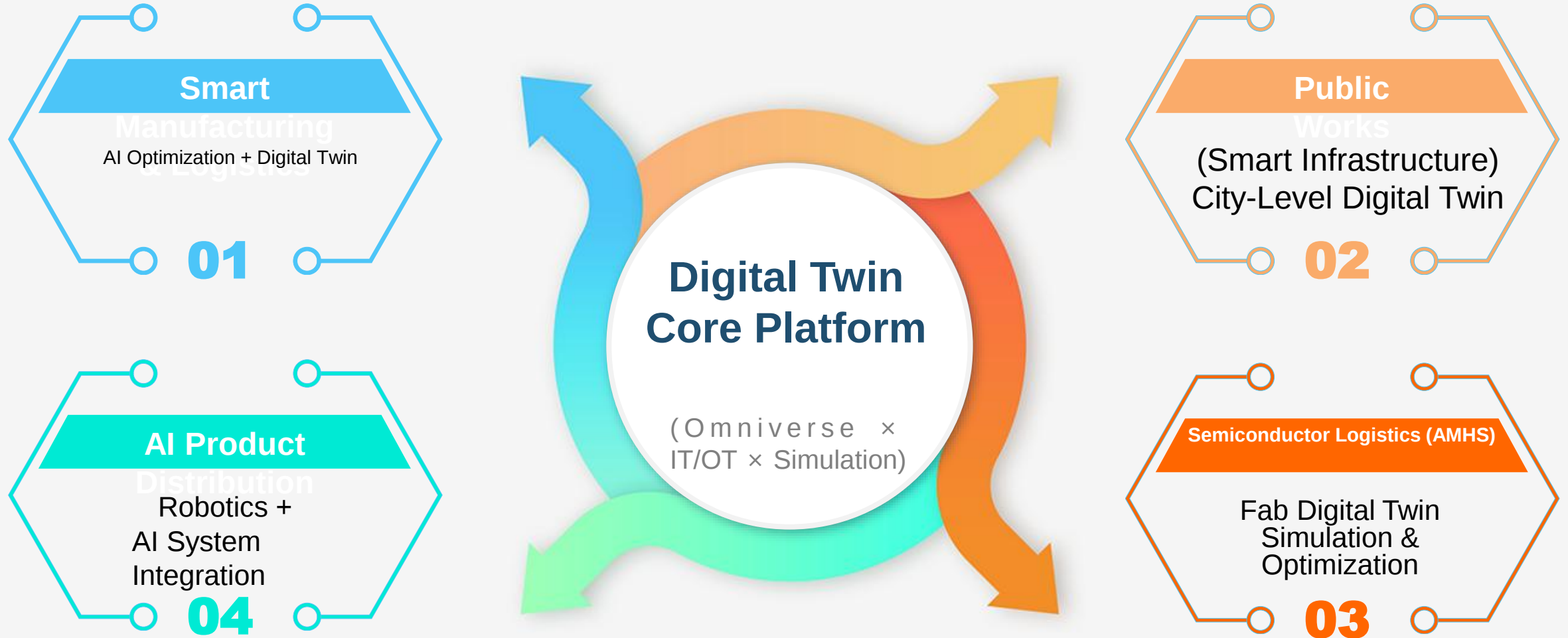
Three core capabilities:

- Omniverse / OpenUSD application capability
- IT / OT data integration capability
- Simulation and validation capability

Digital Twin
Helps improve planning, validation,
and operational optimization
efficiency



Connecting KENMEC' s Four Major Application Fields through a Digital Twin Core Platform



**With Digital Twin as the core capability foundation, supporting smart manufacturing, semiconductor logistics, public works, and AI application integration.

Transforming from “Equipment Integration” to “AI Solution Integration Partner”



Past : Conveyor



Now : System Integration

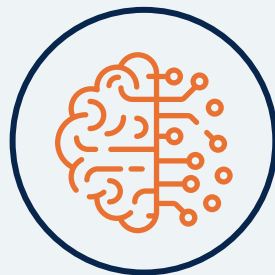


Future : AI Solution Partner



Select Right

Select the world's leading technologies and provide the most suitable configuration



Apply Well

Combine NVIDIA Omniverse with cyber-physical validation to turn AI into on-site productivity



Sustain Value

Provide lifecycle O&M services to ensure long-term benefits

Global Footprint

Global Market Expansion Strategy

Southeast
Asia

Rapid growth in smart factory and logistics demand

United
States

Semiconductor supply chain opportunities

Using system export as the core strategy to replicate smart manufacturing and smart logistics turnkey solutions

System Export of Total Solutions

